

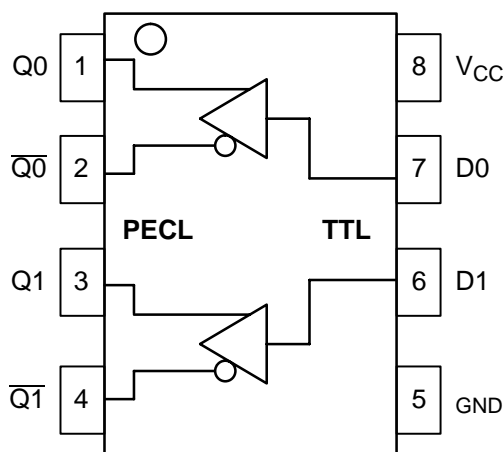
# MC10ELT22, MC100ELT22

## 5V Dual TTL to Differential PECL Translator

The MC10ELT/100ELT22 is a dual TTL to differential PECL translator. Because PECL (Positive ECL) levels are used only +5 V and ground are required. The small outline 8-lead package and the low skew, dual gate design of the ELT22 makes it ideal for applications which require the translation of a clock and a data signal.

- 1.2 ns Typical Propagation Delay
- <300 ps Typical Output to Output Skew
- PNP TTL Inputs for Minimal Loading
- Flow Through Pinouts
- ESD Protection: >2 KV HBM, >200 V MM
- Operating Range:  $V_{CC}$  = 4.75 V to 5.25 V with GND = 0 V
- No Internal Input Pulldown Resistors
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1  
For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL-94 code V-0 @ 1/8",  
Oxygen Index 28 to 34
- Transistor Count = 51 devices

### LOGIC DIAGRAM AND PINOUT ASSIGNMENT



### PIN DESCRIPTION

PIN	FUNCTION
$Q_n, \overline{Q_n}$	PECL Differential Outputs*
$D_n$	TTL Inputs
$V_{CC}$	Positive Supply
GND	Ground

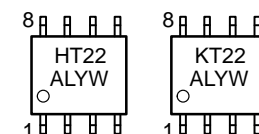
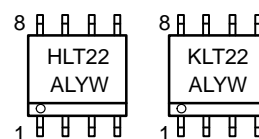
\* Output state undetermined when inputs are open.



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### MARKING DIAGRAMS\*



H = MC10  
K = MC100  
A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week

\*For additional information, see Application Note AND8002/D

### ORDERING INFORMATION

Device	Package	Shipping
MC10ELT22D	SO-8	98 Units/Rail
MC10ELT22DR2	SO-8	2500 Tape & Reel
MC100ELT22D	SO-8	98 Units/Rail
MC100ELT22DR2	SO-8	2500 Tape & Reel
MC10ELT22DT	TSSOP-8	98 Units/Rail
MC10ELT22DTR2	TSSOP-8	2500 Tape & Reel
MC100ELT22DT	TSSOP-8	98 Units/Rail
MC100ELT22DTR2	TSSOP-8	2500 Tape & Reel

# MC10ELT22, MC100ELT22

## MAXIMUM RATINGS (Note 1.)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V <sub>CC</sub>	Positive Power Supply	GND = 0 V		7	V
V <sub>IN</sub>	Input Voltage	GND = 0 V	V <sub>I</sub> ≤ V <sub>CC</sub>	7	V
I <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
T <sub>A</sub>	Operating Temperature Range			−40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			−65 to +150	°C
θ <sub>JA</sub>	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	8 SOIC 8 SOIC	190 130	°C/W °C/W
θ <sub>JC</sub>	Thermal Resistance (Junction to Case)	std bd	8 SOIC	41 to 44	°C/W
θ <sub>JA</sub>	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	8 TSSOP 8 TSSOP	185 140	°C/W °C/W
θ <sub>JC</sub>	Thermal Resistance (Junction to Case)	std bd	8 TSSOP	41 to 44 ± 5%	°C/W
T <sub>sol</sub>	Wave Solder	<2 to 3 sec @ 248°C		265	°C

1. Maximum Ratings are those values beyond which device damage may occur.

## 10ELT SERIES PECL DC CHARACTERISTICS V<sub>CC</sub> = 5.0 V; GND = 0.0 V (Note 1.)

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I <sub>CC</sub>	Power Supply Current			22			22			22	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2.)	3920	4010	4110	4020	4105	4190	4090	4185	4280	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2.)	3050	3200	3350	3050	3210	3370	3050	3227	3405	mV

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

- Output parameters vary 1:1 with V<sub>CC</sub>. V<sub>CC</sub> can vary ± 0.25 V.
- Outputs are terminated through a 50 ohm resistor to V<sub>CC</sub>−2 volts.

## 100ELT SERIES PECL DC CHARACTERISTICS V<sub>CC</sub> = 5.0 V; GND = 0.0 V (Note 1.)

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I <sub>CC</sub>	Power Supply Current			22			22			22	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2.)	3915	3995	4120	3975	4045	4120	3975	4050	4120	mV
V <sub>OL</sub>	Output LOW Voltage (Note 2.)	3170	3305	3445	3190	3295	3380	3190	3295	3380	mV

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

- Output parameters vary 1:1 with V<sub>CC</sub>. V<sub>CC</sub> can vary ± 0.25 V.
- Outputs are terminated through a 50 ohm resistor to V<sub>CC</sub>−2 volts.

# MC10ELT22, MC100ELT22

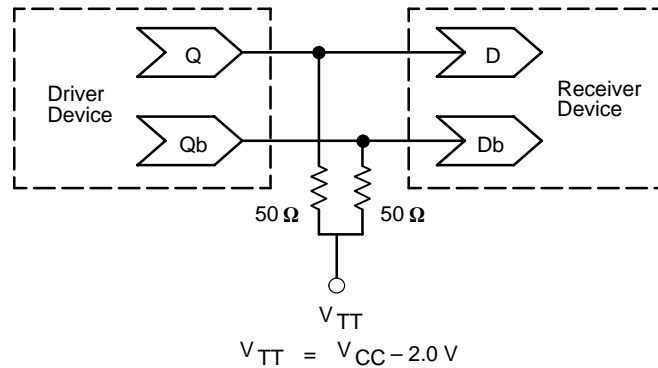
## TTL INPUT DC CHARACTERISTICS $V_{CC} = 4.75 \text{ V to } 5.25 \text{ V}$ ; $T_A = -40^\circ\text{C to } 85^\circ\text{C}$

Symbol	Characteristic	Condition	Min	Typ	Max	Unit
$I_{IH}$	Input HIGH Current	$V_{IN} = 2.7 \text{ V}$			20	$\mu\text{A}$
$I_{IHH}$	Input HIGH Current	$V_{IN} = 7.0 \text{ V}$			100	$\mu\text{A}$
$I_{IL}$	Input LOW Current	$V_{IN} = 0.5 \text{ V}$			-0.6	$\text{mA}$
$V_{IK}$	Input Clamp Diode Voltage	$I_{IN} = -18 \text{ mA}$			-1.2	$\text{V}$
$V_{IH}$	Input HIGH Voltage		2.0			$\text{V}$
$V_{IL}$	Input LOW Voltage				0.8	$\text{V}$

## AC CHARACTERISTICS $V_{CC} = 4.75 \text{ V to } 5.25 \text{ V}$ ; $\text{GND} = 0.0 \text{ V}$

Symbol	Characteristic	$-40^\circ\text{C}$			$25^\circ\text{C}$			$85^\circ\text{C}$			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
$f_{\text{MAX}}$	Maximum Input Frequency	100			100			100			$\text{MHz}$
$t_{\text{PLH}}$	Propagation Delay (Note 1.) 1.5 V to 50%	0.6		1.2	0.9	1.2	1.5	0.6		1.35	$\text{ns}$
$t_{\text{PHL}}$	Propagation Delay (Note 1.) 1.5 V to 50%	0.4		1.0	0.5	0.8	1.1	0.7		1.30	$\text{ns}$
$t_{\text{JITTER}}$	Cycle-to-Cycle Jitter			TBD	TBD			TBD			$\text{ps}$
$t_r/t_f$	Output Rise/Fall Time (20–80%)	0.4		1.6	0.4		1.6	0.4		1.6	$\text{ns}$

1. Specifications for standard TTL input signal.



**Figure 1. Typical Termination for Output Driver and Device Evaluation**  
 (See Application Note AND8020 – Termination of ECL Logic Devices.)

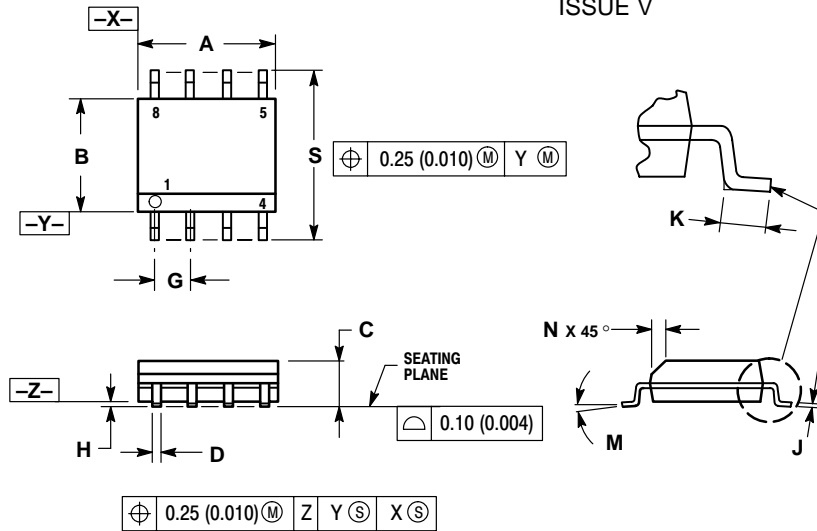
### Resource Reference of Application Notes

- AN1400** – MC10/100H640 Clock Driver Family I/O SPICE Modeling Kit
- AN1404** – ECLinPS Circuit Performance at Non–Standard  $V_{IH}$  Levels
- AN1405** – ECL Clock Distribution Techniques
- AN1406** – Designing with PECL (ECL at +5.0 V)
- AN1503** – ECLinPS I/O SPICE Modeling Kit
- AN1504** – Metastability and the ECLinPS Family
- AN1560** – Low Voltage ECLinPS SPICE Modeling Kit
- AN1568** – Interfacing Between LVDS and ECL
- AN1596** – ECLinPS Lite Translator ELT Family SPICE I/O Model Kit
- AN1650** – Using Wire–OR Ties in ECLinPS Designs
- AN1672** – The ECL Translator Guide
- AND8001** – Odd Number Counters Design
- AND8002** – Marking and Date Codes
- AND8020** – Termination of ECL Logic Devices

# MC10ELT22, MC100ELT22

## PACKAGE DIMENSIONS

### SO-8 D SUFFIX PLASTIC SOIC PACKAGE CASE 751-07 ISSUE V



#### NOTES:

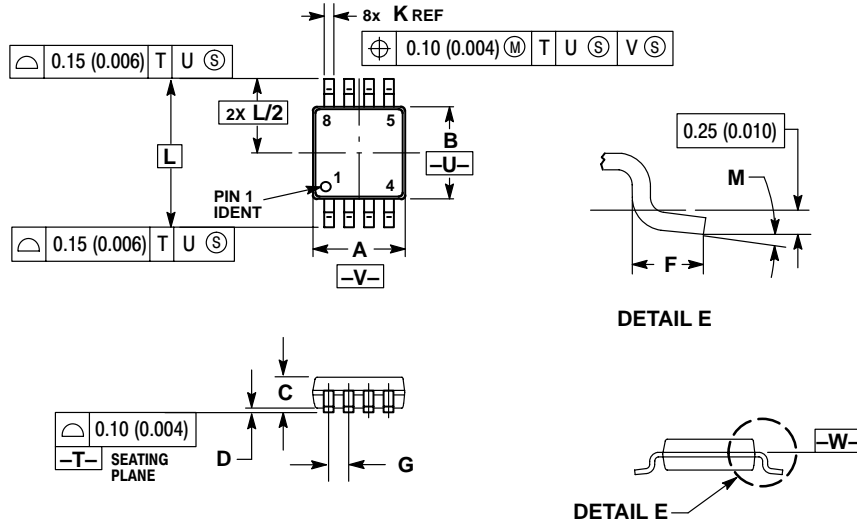
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

# MC10ELT22, MC100ELT22

## PACKAGE DIMENSIONS

**TSSOP-8**  
**DT SUFFIX**  
 PLASTIC TSSOP PACKAGE  
 CASE 948R-02  
 ISSUE A




### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.90	3.10	0.114	0.122
B	2.90	3.10	0.114	0.122
C	0.80	1.10	0.031	0.043
D	0.05	0.15	0.002	0.006
F	0.40	0.70	0.016	0.028
G	0.65 BSC		0.026 BSC	
K	0.25	0.40	0.010	0.016
L	4.90 BSC		0.193 BSC	
M	0°	6°	0°	6°

## **Notes**

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